<u>SENSITRON</u> SEMICONDUCTOR

TECHNICAL DATA DATASHEET 4938, Rev A

SILICON SCHOTTKY RECTIFIER DIE Very Low Forward Voltage Drop

Applications:

• Switching Power Supply • Converters • Free-Wheeling Diodes • Polarity Protection Diode

Features:

- Soft Reverse Recovery at Low and High Temperature
- Very Low Forward Voltage Drop
- Low Reverse Leakage Current
- Low Power Loss, High Efficiency
- High Surge Capacity
- Guard Ring for Enhanced Durability and Long Term Reliability
- Guaranteed Reverse Avalanche Characteristics
- Electrically / Mechanically Stable during and after Packaging

Maximum Ratings:

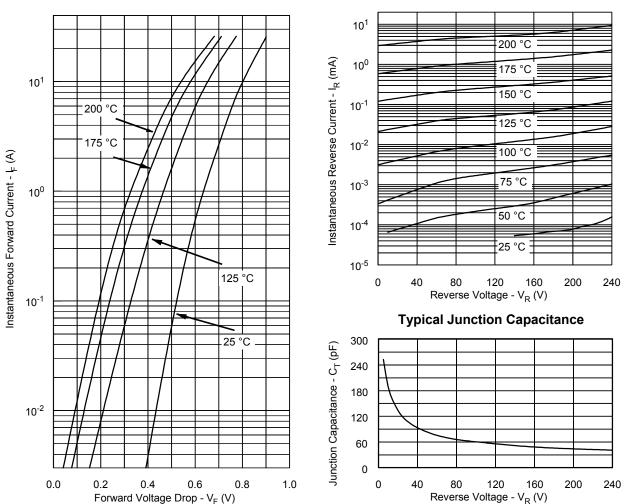
Characteristics	Symbol	Condition	Max.	Units
Peak Inverse Voltage	V _{RWM}	-	200	V
Max. Average Forward Current	I _{F(AV)}	50% duty cycle, rectangular wave form	15	A
Max. Peak One Cycle Non- Repetitive Surge Current	I _{FSM}	8.3 ms, half Sine wave ⁽¹⁾	280	A
Non-Repetitive Avalanche Energy	E _{AS}	T _J = 25 °C, I _{AS} = 0.6 A, L = 40mH	7.2	mJ
Repetitive Avalanche Current	I _{AR}	I_{AS} decay linearly to 0 in 1 µs f limited by T _J max V _A =1.5V _R	0.6	A
Max. Junction Temperature	TJ	-	-65 to +200	°C
Max. Storage Temperature	T _{stg}	-	-65 to +200	°C

Electrical Characteristics:

Characteristics	Symbol	Condition	Max.	Units
Max. Forward Voltage Drop	V_{F1}	@ 15A, Pulse, T _J = 25 °C	0.92	V
	V _{F2}	@ 15A, Pulse, T _J = 125 °C	0.76	V
Max. Reverse Current	I _{R1}	@V _R = 200V, Pulse,	350	μA
		T _J = 25 °C		
	I _{R2}	@V _R = 200V, Pulse,	8	mA
		T _J = 125 °C		
Max. Junction Capacitance	CT	@V _R = 5V, T _C = 25 °C	300	pF
		f _{SIG} = 1MHz,		
		V _{SIG} = 50mV (p-p)		

(1) in SHD package

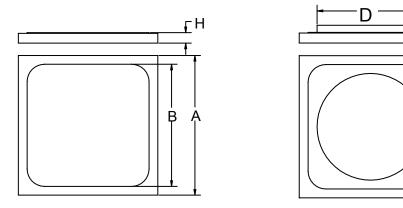
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Typical Forward Characteristics

Typical Reverse Characteristics

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Mechanical Dimensions: In Inches / mm

Figure 1

Figure 2

Α	В	D	Н	h
0.125±0.003	0.116±0.003	0.070 ± 0.005	0.0155±0.001	0.010 ± 0.002

Top side(Anode) metallization: A = AI - 25 kÅ minimum, Figure 1 B = Ag - 30 kÅ minimum, Figure 1 C = Au - 12 kÅ min, Figure 2

Bottom side (Cathode) metallization: A, B, C = Ti/Ni/Ag - 30 kÅ minimum.

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